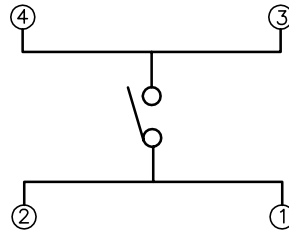
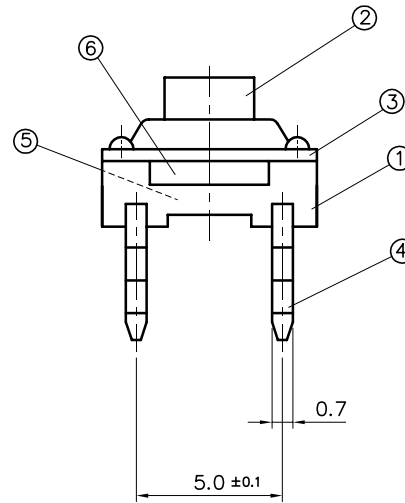
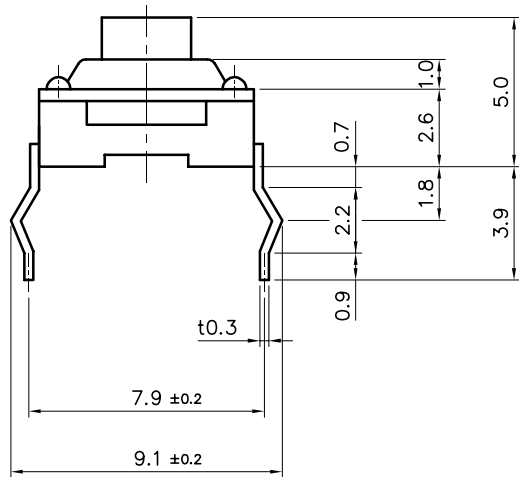


CIRCUIT DIAGRAM



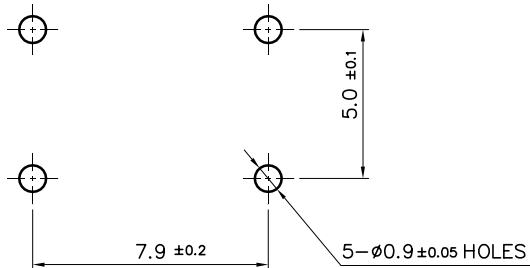
| NO | PARTS | Q'TY | MATERIAL | REMARK |
|----|----------|------|-----------------|-------------|
| 1 | CASE | 1 | NYLON 66 -V0 | |
| 2 | STEM | 1 | NYLON 66 -V0 | |
| 3 | COVER | 1 | t0.3 C2680R-EH | Sn3 μ |
| 4 | TERMINAL | 1 | t0.3 C2680R-EH | Ag0.5 μ |
| 5 | C/PLATE | 1 | t0.06 C5210R-EH | Ag0.5 μ |
| 6 | RUBBER | 1 | SILICON | |
| 7 | TAPE | 1 | | |



NOTE

1. OPERATING FORCE : 200 \pm 30gf
2. GENERAL TOLERANCE : \pm 0.3
3. TRAVEL : 0.25 $^{+0.2}_{-0.1}$ m/m
4. CONTACT RESISTANCE : 100m Ω MAX
5. MANUFACTURING SPECIFICATION WOULD BE ACCORDANCE WITH WP0002
6. ULTRASONIC CLEANING IS POSSIBLE AFTER AUTO-DIPPING
7. DRIP-PROOF DUST-PROOF STRUCTURE

PCB DIMENSION



| PART NO | PART NAME | Q'TY | MATERIAL | STANDARD | DISPOSITION | REMARKS |
|---------|------------|---------|---------------|----------|-------------|--------------------|
| △ | | | TRIGON-OMETRY | UNIT | SCALE | WATER PROOF |
| △ | | | APPD | CHKD | DSGD | |
| △ | | | | | | |
| △ | | | | | | |
| NO | CORRECTION | 91.7.19 | | | MODEL | TP1119 |